



DMT31M7LPS

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
	1.7mΩ @ V _{GS} = 10V	100A
30V	2.4mΩ @ V _{GS} = 4.5V	80A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- Power Management Functions
- DC-DC Converters

N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Features and Benefits

- Low R_{DS(ON)} Minimizes On-State Losses
- Excellent Q_{gd} x R_{DS(ON)} Product (FOM)
- Advanced Technology for DC-DC Converters
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- 100% Unclamped Inductive Switching Ensures More Reliability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ³

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Top View

Pin Configuration

Weight: 0.097 grams (Approximate)

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Internal Schematic



Ordering Information (Note 4)

Part Number	Case	Packaging	
DMT31M7LPS-13	PowerDI5060-8	2,500/Tape & Reel	

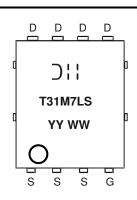
Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

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Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



); ; = Manufacturer's Marking
 T31M7LS = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 18 = 2018)
 WW = Week (01 to 53)

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	30	V	
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	30 24	А
Continuous Drain Current, $V_{GS} = 10V$ (Note 7)	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	ID	100 80	А
Maximum Continuous Body Diode Forward Current (Note	6)	Is	2.8	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	IDM	400	А	
Pulsed Body Diode Forward Current (380µs Pulse, Duty (I _{SM}	400	А	
Avalanche Current, L=0.1mH (Note 8)	IAS	65	А	
Avalanche Energy, L=0.1mH (Note 8)		E _{AS}	215	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.3	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	94	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.4	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	52	°C/W
Total Power Dissipation (Note 7)	T _C = +25°C	PD	113	W
Thermal Resistance, Junction to Case (Note 7)		R _θ JC	1.1	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS		_	1	μA	$V_{DS} = 24V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_		±100	nA	$V_{GS} = 20V, V_{DS} = 0V$ $V_{GS} = -16V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	V _{GS(TH)}	1.0	_	3.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance		_	1.3	1.7	mΩ	V _{GS} = 10V, I _D = 20A
Static Drain-Source On-Resistance	R _{DS(ON)}	_	1.9	2.4		$V_{GS} = 4.5V, I_D = 20A$
Diode Forward Voltage	V _{SD}	—	0.7	1.0	V	$V_{GS} = 0V, I_S = 2A$
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	C _{iss}	—	5741	_		$\label{eq:VDS} \begin{split} V_{DS} &= 15V, V_{GS} = 0V, \\ f &= 1.0MHz \end{split}$
Output Capacitance	Coss		2119	_	pF	
Reverse Transfer Capacitance	C _{rss}	_	424	—		
Gate Resistance	Rg	—	1.5	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 10V)	Qg	_	90	_		
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	45	_	nC	$V_{DD}=15V,I_D=20A$
Gate-Source Charge	Q _{gs}	_	11.6	—	no	
Gate-Drain Charge	Q _{gd}	_	21.6	_		
Turn-On Delay Time	t _{D(ON)}	_	6.9	_		$\label{eq:VDD} \begin{split} V_{DD} &= 15V, V_{GS} = 10V, \\ R_g &= 3\Omega, I_D = 20A \end{split}$
Turn-On Rise Time	t _R		16.5	_	20	
Turn-Off Delay Time	t _{D(OFF)}		49.6	_	ns	
Turn-Off Fall Time	tF		34.5	_		
Reverse Recovery Time	t _{RR}		32.5	_	ns	I _F = 15A, dl/dt = 500A/µs
Reverse Recovery Charge	Q _{RR}		55	_	nC	I _F = 15A, dl/dt = 500A/µs

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

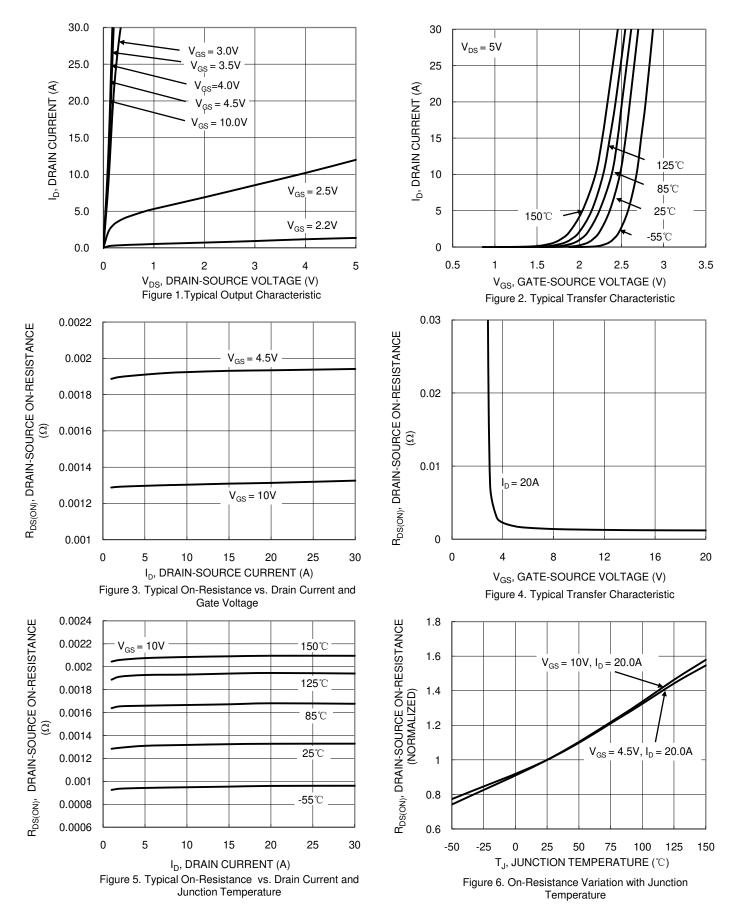
6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. 7. Thermal resistance from junction to soldering point (on the exposed drain pad). 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to product testing.

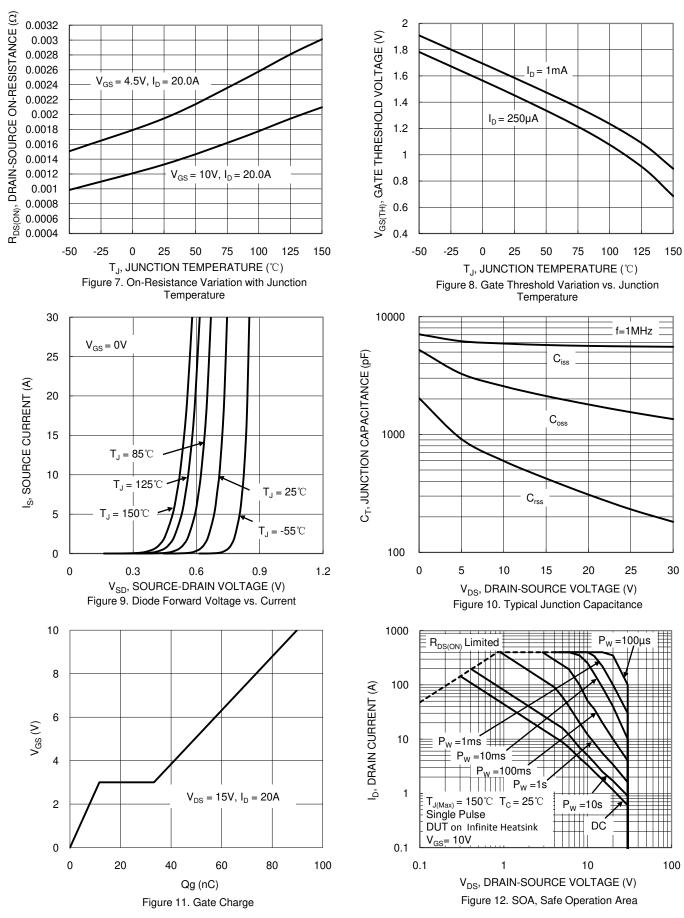


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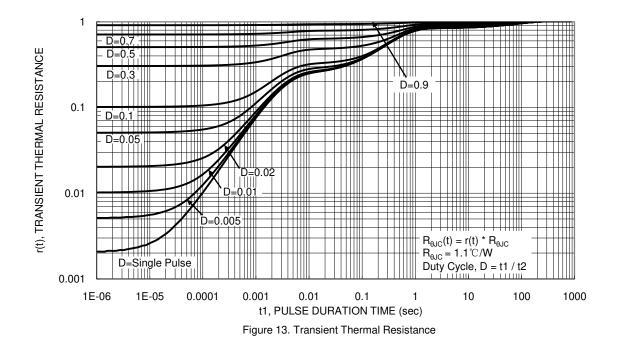
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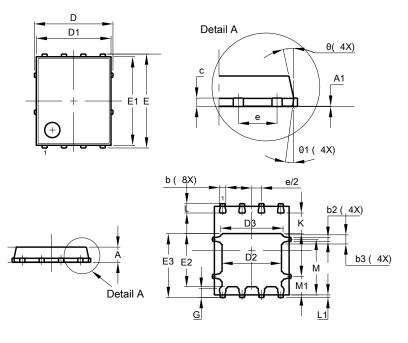




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

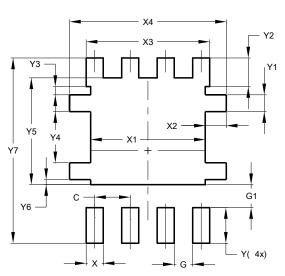
PowerDI5060-8



PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	ļ	5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
E		6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
Al	All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
Х	0.610			
X1	4.100			
X2	0.755			
X3	4.420			
X4	5.610			
Y	1.270			
Y1	0.600			
Y2	1.020			
Y3	0.295			
Y4	1.825			
Y5	3.810			
Y6	0.180			
¥7	6.610			

PowerDI5060-8



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